### **Overview**

### HP ProBook 450 15.6" G9 Notebook PC



- 1. Internal Microphones (2)
- 2. Webcam LED (Optional)
- 3. Camera Shutter
- 4. Combo Web/IR Camera (Optional)

#### Left

- 5. Clickpad
- 6. SuperSpeed USB Type-A 5Gbps signaling rate port (USB 3.2 Gen 1)
- 7. Ethernet Port (RJ-45)
- 8. Nano Security Lock Slot (Lock sold separately)



### **Overview**



- 1. Power Button Key
- 2. Power Connector
- **3.** SuperSpeed USB Type-C<sup>®</sup> 10Gbps signaling rate (USB Power Delivery, DisplayPort<sup>™</sup> 2.1)
- **4.** SuperSpeed USB Type-A 5Gbps signaling rate port (USB 3.2 Gen 1)
- 5. SuperSpeed USB Type-A 5Gbps signaling rate port (USB 3.2 Gen 1)

#### Right

- 6. HDMI 2.1 Port (Cable not included)
- 7. Audio Combo Jack
- 8. External SIM (WWAN Optional Model)
- 9. Touch Fingerprint Sensor (Select Models)



### Overview

#### AT A GLANCE

- Preinstalled with Windows 11 versions or FreeDOS
- Choice of 12th generation Intel<sup>®</sup> Core<sup>™</sup> i7, i5 and i3 processors
- Optional NVIDIA<sup>®</sup> GeForce<sup>®</sup> MX570 Controller with 2 GB GDDR6 video memory
- Fast and upgradeable dual channel DDR4 SODIMM memory up to 32 GB
- Choice of 39.62 cm (15.6") diagonal HD, Ultra Wide Viewing Angle FHD, Touch or Non-Touch screen
- Features redesigned quiet and responsive HP Keyboard with the HP Programmable key and backlit options
- Choice of solid state drives up to 1 TB, 2nd SSD 128GB/256GB (Optional)
- Multi-layered security with HP SureStart Gen6, HP Priva7y Camera, HP Sure View Gen4<sup>1</sup>, HP Sure Sense G2, HP Sure Click, and Touch Fingerprint reader<sup>2</sup>, Tamper Lock, HP Wolf Security
- Supports wireless options for connectivity on the go including gigabit-speed up to Wi-Fi® 6E and CAT16 4G/LTE WWAN
- Supports fast charging (50% in 30 minutes) with no impact on battery recharge cycles<sup>3</sup>
- Designed to support HP docking options
- Passed MIL-STD 810H tests<sup>4</sup>
- Battery options 42.75 Wh and 51.3 Wh
- Battery life up to 12 hours and 15 minutes
- Optimize your video calls with an HD camera and Temporal Noise Reduction that adjusts to the lighting in your environment.

1. HP Sure View integrated privacy screen is an optional feature that must be configured at purchase and is designed to function in landscape orientation.

2. Sold separately or as an optional feature.

3. HP notebooks up to 50% within 30 minutes when the system is off or in standby mode. Power adapter with a minimum capacity of 65 watts is required. After charging has reached 50% capacity, charging will return to normal. Charging time may vary +/-10% due to System tolerance.

4. MIL STD 810H testing is not intended to demonstrate fitness for U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack.

#### NOTE: See important legal disclosures for all listed specs in their respective features sections.



#### **PRODUCT NAME**

HP ProBook 450 15.6" G9 Notebook PC

#### **OPERATING SYSTEM**

PreinstalledWindows 11 Pro 1<br/>Windows 11 Pro Education 1<br/>Windows 11 Home - HP recommends Windows 11 Pro for business 1<br/>Windows 11 Home Single Language - HP recommends Windows 11 Pro for business 1<br/>Windows 11 Pro (Windows 11 Enterprise available with a Volume Licensing Agreement) 1<br/>Windows 10 Pro (available through downgrade rights from Windows 11 Pro) 1,2<br/>FreeDOS

1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.

2. This system is preinstalled with Windows 10 Pro software and also comes with a license for Windows 11 Pro software and provision for recovery software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

Processor <sup>3,4,5,6</sup>	Number Cores of	Number of Threads	L3 Cache	Max Turbo Frequency		Base Frequency			
		P-cores	E-cores			P-cores	E-cores	P-cores	E-cores
Intel® Core™ i7- 1260P	12	4	8	16	18MB	4.7 GHz	3.4 GHz	2.1 GHz	1.5 GHz
Intel <sup>®</sup> Core™ i5- 1240P	12	4	8	16	12MB	4.4 GHz	3.3 GHz	1.7 GHz	1.2 GHz
Intel® Core™ i7- 1255U	10	2	8	12	12MB	4.7 GHz	3.5 GHz	1.7 GHz	1.2 GHz
Intel <sup>®</sup> Core™ i5- 1235U	10	2	8	12	12MB	4.4 GHz	3.3 GHz	1.3 GHz	0.9 GHz
Intel® Core™ i3- 1215U	6	2	4	8	10MB	4.4 GHz	3.3 GHz	1.2 GHz	0.9 GHz
Intel <sup>®</sup> Pentium <sup>®</sup> Gold 8505	5	1	4	6	8MB	4.4 GHz	3.3 GHz	1.2 GHz	0.9 GHz
Intel <sup>®</sup> Celeron <sup>®</sup> 7305	5	1	4	6	8MB	N/A	N/A	1.1 GHz	0.9 GHz

#### PROCESSORS

3. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application



## **Technical Specifications**

workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

4. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.

5. Intel® Turbo Boost performance varies depending on hardware, software and overall system configuration. See http://www.intel.com/technology/turboboost for more information.

6. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.

#### CHIPSET

Chipset is integrated with processor

#### GRAPHICS

#### Integrated

Intel<sup>®</sup> Iris<sup>®</sup> X Graphics (Core i5 and Core i7)<sup>7</sup> Intel<sup>®</sup> UHD Graphics (Core i3)

#### Discrete

NVIDIA® GeForce® MX570 Controller

#### Support

Support HD decode, DX12, HDMI 2.1 <sup>8</sup>

7. Intel<sup>®</sup> Iris<sup>®</sup> X<sup>e</sup> Graphics capabilities require system to be configured with Intel<sup>®</sup> Core<sup>™</sup> i5 or i7 processors and dual channel memory. Intel<sup>®</sup> Iris<sup>®</sup> X<sup>e</sup> Graphics with Intel<sup>®</sup> Core<sup>™</sup> i5 or 7 processors and single channel memory will only function as UHD graphics.

8. HD content required to view HD images.

#### DISPLAY

#### Non-Touch

39.6 cm (15.6") diagonal FHD UWVA eDP anti-glare, low power narrow bezel bent, 400 nits, 100% sRBG for HD TNR camera (1920 x 1080)<sup>8,9</sup>

39.6 cm (15.6") diagonal FHD UWVA eDP+PSR anti-glare, low power narrow bezel bent, 400 nits, 100% sRGB for HD+IR camera (1920 x 1080)<sup>8,9</sup>

39.6 cm (15.6") diagonal FHD UWVA eDP anti-glare, narrow bezel bent, 250 nits, 45% NTSC (1920 x 1080)<sup>8,9</sup> 39.6 cm (15.6") diagonal FHD UWVA eDP anti-glare, narrow bezel bent, 250 nits, 45% NTSC for HD TNR camera (1920 x 1080)<sup>8,9</sup>

39.6 cm (15.6") diagonal FHD UWVA eDP anti-glare, narrow bezel bent, 250 nits, 45% NTSC for HD + IR camera (1920 x 1080)<sup>8,9</sup>

39.6 cm (15.6") diagonal FHD UWVA eDP anti-glare, narrow bezel bent, 250 nits, 45% NTSC for HD TNR camera and WWAN (1920 x 1080) <sup>8,9</sup>

39.6 cm (15.6") diagonal HD SVA eDP + PSR anti-glare, narrow bezel bent, 250 nits, 45% NTSC (1366 x 768) <sup>8,9</sup> 39.6 cm (15.6") diagonal HD SVA eDP anti-glare, narrow bezel bent, 250 nits, 45% NTSC for HD TNR camera (1366 x 768) <sup>8,9</sup>



## **Technical Specifications**

39.6 cm (15.6") diagonal HD SVA eDP anti-glare, narrow bezel bent, 250 nits, 45% NTSC for HD+IR camera (1366 x 768)<sup>8,9</sup> 39.6 cm (15.6") diagonal HD SVA eDP anti-glare, narrow bezel bent, 250 nits, 45% NTSC for HD TNR camera and WWAN (1366 x 768)<sup>8,9</sup>

#### Touch

39.6 cm (15.6") diagonal FHD UWVA eDP + PSR anti-glare, narrow bezel bent, touch-on-panel screen, 250 nits, 45% NTSC for HD + IR camera (1920 x 1080) <sup>8,9,10,11</sup>

39.6 cm (15.6") diagonal FHD UWVA eDP + PSR anti-glare, narrow bezel bent touch-on-panel screen, 250 nits, 45% NTSC for HD + IR camera and WWAN (1920 x 1080)<sup>8,9,10,11</sup>

#### HDMI

Support resolutions up to 4k 60Hz

#### Display Size

15.6" diagonal 39.6 cm (15.6") diagonal

8. HD content required to view HD images.
9. Resolutions are dependent upon monitor capability, and resolution and color depth settings.
10. Sold separately or as an optional feature.

11. Actual brightness will be lower with touchscreen or HP Sure View.

#### **DOCKING (Sold Separately)**

Docking station model #1HP USB-C Dock G5Docking station model #2HP USB-C/A Universal Dock G2Docking station model #3HP Thunderbolt Dock G2For additional aftermarket options and docking specs please see page 38.

#### **STORAGE AND DRIVES**

#### Primary M.2 Storage

1 TB PCIe<sup>®</sup> NVMe<sup>™</sup> M.2 TLC Solid State Drive <sup>12</sup> 512 GB PCIe<sup>®</sup> NVMe<sup>™</sup> M.2 Value Solid State Drive <sup>12</sup> 256 GB PCIe<sup>®</sup> NVMe<sup>™</sup> M.2 Value Solid State Drive <sup>12</sup> 128 GB PCIe<sup>®</sup> NVMe<sup>™</sup> M.2 Value Solid State Drive <sup>12</sup>

#### Secondary M.2 Storage

256 GB PCIe<sup>®</sup> NVMe<sup>™</sup> M.2 Value Solid State Drive <sup>13</sup> 128 GB PCIe<sup>®</sup> NVMe<sup>™</sup> M.2 Value Solid State Drive <sup>13</sup>

12. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 and 11) is reserved for system recovery software.

13. Second storage is only available with non-WWAN base Unit AND Primary M.2 storage.



#### MEMORY

Maximum Memory 32 GB DDR4-3200 SDRAM <sup>14</sup>

#### Memory

32 GB DDR4-3200 SDRAM (2 x 16 GB) <sup>14</sup> 16 GB DDR4-3200 SDRAM (1 x 16 GB) <sup>14</sup> 16 GB DDR4-3200 SDRAM (2 x 8 GB) <sup>14</sup> 12 GB DDR4- 3200 SDRAM (1 x 4 GB + 1 x 8 GB) <sup>14</sup> 8 GB DDR4-3200 SDRAM (1 x 8 GB) <sup>14</sup> 8 GB DDR4-3200 SDRAM (2 x 4 GB) <sup>14</sup> 4 GB DDR4-3200 SDRAM (1 x 4 GB) <sup>14</sup>

#### **Memory Slots**

#### 2 SODIMM Both slots are accessible/upgradeable by IT or self-maintainers only. DDR4 PC4 SODIMMS, system runs at 3200 Supports Dual Channel Memory

14. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.



#### **NETWORKING/COMMUNICATIONS**

#### WLAN

Intel® AX211 Wi-Fi6E +Bluetooth® 5.2 M.2 2230 160MHz CNVi World-Wide WLAN <sup>15</sup> Realtek 8852BE Wi-Fi 6 + Bluetooth® 5.2 M.2 2230 PCI-e+USB World-Wide WLAN <sup>16</sup>

#### WWAN

Intel<sup>®</sup> XMM 7560 R+ LTE-Advanced Pro Cat 16<sup>17</sup>

#### Miracast

**Native Miracast Support** 

#### Ethernet

Realtek RTL8111HSH 10/100/1000 Integrated NIC <sup>18</sup>

#### Wake on WLAN

Support on S3 AC mode only

15. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

16. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 (802.11ax) is backwards compatible with prior 802.11 specs. Wi-Fi 6<sup>™</sup> is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

17. WWAN module is optional, must be configured at the factory and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.

18. The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

#### AUDIO/MULTIMEDIA

#### Audio

2 Integrated stereo speakers Integrated microphone (Dual Array)

#### **Speaker Power**

2W/4ohm per speaker

#### Camera

720p HD camera with Temporal Noise Reduction <sup>9</sup> 720p HD camera+IR Camera <sup>8,10</sup>

8. HD content required to view HD images. 10. Sold separately or as an optional feature.



#### **KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS**

#### Keyboard

HP Premium Keyboard, full-size, spill resistant with numeric keypad and optional backlit <sup>19</sup>

#### **Pointing Device**

Clickpad with multi-touch gesture support

#### **Function Keys**

- F1 Display Switching
- F2 Blank or SureView On/Off
- F3 Brightness Down
- F4 Brightness Up
- F5 Audio Mute
- F6 Volume Down
- F7 Volume Up
- F8 Mic Mute
- F9 Blank or Backlit Toggle
- F10 Insert
- F11 Airplane Mode
- F12 Programmable key
- Print Screen
- Power Button (with LED)

#### **Hidden Function Keys**

Fn+R - Break Fn+S - Sys Rq Fn+C - Scroll Lock

19. Backlit keyboard is an optional feature.



#### SOFTWARE AND SECURITY

#### Software

HP Quick Drop<sup>20</sup> HP PC Hardware Diagnostics Windows myHP Tile App <sup>21</sup> HP Smart Support <sup>22</sup> HP Connection Optimizer HP Hotkey Support HP Support Assistant <sup>23</sup> HP Notifications HP Power Manager HP Privacy Settings Buy Microsoft Office (Sold separately)

#### **Manageability Features**

HP Image Assistant Gen5 (download) HP Manageability Integration Kit (download)<sup>24</sup> HP Client Management Script Library (download) HP Driver Packs (download) HP Client Catalog (download))

#### **Security Management**

#### HP Wolf Security of Business<sup>25</sup> includes:

HP Sure Click<sup>26</sup> HP Sure Sense2<sup>27</sup> HP Sure Start Gen7<sup>28</sup> HP Tamper Lock HP Sure Admin<sup>29</sup>

#### BIOS

HP BIOSphere Gen6 <sup>30</sup> HP Secure Erase <sup>31</sup> Absolute Persistence Module <sup>32</sup> HP DriveLock & Automatic DriveLock BIOS Update via Network HP Wake on WLAN TPM 2.0 Embedded Security Chip (Common Criteria EAL4+ Certified) (FIPS 140-2 Level 2 Certified) HP Fingerprint Sensor <sup>33</sup>

#### Security

#### ТРМ

Model: Nuvoton NPCT760HAAYX Version: 7.2.3.0 Revision: TPM 2.0 FIPS 140-2 Compliant: Yes

#### IPv6 Support

твс



#### **FirstNet Certified**

No

#### Is the BIOS on this notebook ISO/IEC 19678:2015 (formerly NIST 800-147) compliant?: Yes

UEFI version: 2.7 Class: 3

20. HP Quick Drop requires Internet access and Windows 10 or higher PC preinstalled with HP QuickDrop app and either an Android device (phone or tablet) running Android 7 or higher with the Android HP QuickDrop app, and /or an iOS device (phone or tablet) running iOS 12 or higher with the iOS HP QuickDrop app.

21. Some Tile features require optional subscription to Tile Premium. Tile application for Windows 10 or higher available for download from the Windows Store. Mobile phone app available for download from App Store and Google Play. Requires iOS 11 and greater or Android 6.0 and greater see https://support.thetileapp.com/hc/en-us/articles/200424778 for more information. Tile will function as long as the PC has battery power.

22. HP Smart Support automatically collects the telemetry necessary upon initial boot of the product to deliver device-level configuration data and health insights and is available preinstalled on select products, thru HP Factory Configuration Services; or it can be downloaded. For more information about how to enable HP Smart Support or for download, please visit http://www.hp.com/smart-support.

23. HP Support Assistant requires Windows and Internet Access

24. HP Manageability Integration Kit can be downloaded from http://www.hp.com/go/clientmanagement.

25. HP Wolf Security for Business requires Windows 10 or higher, includes various HP security features and is available on HP Pro, Elite, RPOS and Workstation products. See product details for included security features and OS requirement.

26. HP Sure Click requires Windows 10 Pro or higher or Enterprise. See https://bit.ly/2PrLT6A\_SureClick for complete details. 27. HP Sure Sense is available on select HP PCs with Windows 10 Pro, Windows 10 Enterprise, Windows 11 Pro, or Windows 11 Enterprise OS.

28. HP Sure Start Gen7 is available on select HP PCs and requires Windows 10 and higher

29. HP Sure Admin requires Windows 10 or higher, HP BIOS, HP Manageability Integration Kit from

http://www.hp.com/go/clientmanagement and HP Sure Admin Local Access Authenticator smartphone app from the Android or Apple store.

30. HP BIOSphere Gen6 features may vary depending on the platform and configuration.

31. For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel<sup>®</sup> Optane<sup>™</sup>.

32. Absolute firmware module is shipped turned off and can only be activated with the purchase a license subscription and full activation of the software agent. License subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. Certain conditions apply. For full details visit: https://www.absolute.com/about/legal/agreements/absolute/.

33. HP Fingerprint Reader is an optional feature that must be configured at purchase.

#### POWER

#### **Power Supply**

HP Smart 65 W External AC power adapter <sup>34</sup> HP Smart 65 W EM External AC power adapter <sup>34</sup> HP Smart 65 W USB Type-C adapter <sup>34</sup> HP Smart 45 W External AC power adapter <sup>34</sup> HP Smart 45 W USB Type-C adapter <sup>34</sup>

#### Battery

HP Long Life 3-cell, 42.75 Wh Polymer <sup>35,36</sup> HP Long Life 3-cell, 51.3 Wh Polymer <sup>35,36</sup> Compliant with UL 1642 Standard

#### Power Cord

3-wire plug – 1 <sup>34</sup> 2-wire plug - 1 <sup>34</sup>

#### **Battery life**

Up to 12 hours and 15 minutes with 51whr battery (HP Long Life 3-Cell, 51 Whr Polymer, UMA graphic, Intel U15, 200 nits display, 2\*4G memory, 256 GB SSD)<sup>37</sup>

Up to 12 hours and 15 minutes with 51whr battery (HP Long Life 3-Cell, 51 Whr Polymer, UMA graphic, Intel P28, 200 nits display, 2\*4G memory, 256 GB SSD)<sup>37</sup>

Up to 10 hours and 30 minutes with 42whr battery (HP Long Life 3-Cell, 42 Whr Polymer, UMA graphic, Intel U15, 200 nits display, 2\*4G memory, 256 GB SSD) <sup>37</sup>

#### 34. Availability may vary by country.

35. Battery is internal and not replaceable by customer. Serviceable by warranty.

36. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.

37. Windows 10 MM18 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See http://www.bapco.com for additional details.

#### **WEIGHTS & DIMENSIONS**

#### **Product Weight**

**42.75Wh** Starting at 3.83 lb <sup>38</sup> Starting at 1.74 kg <sup>38</sup>

#### 51.3 Wh

Starting at 3.96 lb <sup>38</sup> Starting at 1.79 kg <sup>38</sup>

#### Product Dimensions (W x D x H)

14.15 x 9.21 x 0.78 in 35.94 x 23.39 x 1.99 cm



38. Weight will vary by configuration. Does not include power adapter.

#### **PORTS/SLOTS**

SuperSpeed USB Type-C<sup>®</sup> 10Gbps signaling rate (USB Power Delivery, DisplayPort<sup>™</sup> 2.1)
 SuperSpeed USB Type-A 5Gbps signaling rate includes 1 charging, 1 powered port (USB 3.2 Gen 1)
 HDMI 2.1 <sup>39</sup>
 RJ-45
 Headphone/microphone combo jack
 AC power
 External Nano SIM slot for WWAN (optional)

39. HDMI cable sold separately.



#### **SERVICE AND SUPPORT**

HP Services offers 1-year or 3-year limited warranties and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty except for Long Life batteries which will have same 1-year or 3-year limited warranty as the platform. Refer to http://www.hp.com/support/batterywarranty/ for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc.<sup>40</sup>

40. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit http://www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.



#### SYSTEM UNIT

Stand-Alone Power Requirements (AC Power)	
Nominal Operating Voltage	19V
Average Operating Power	U15 UMA 3.72W/U15 DSC 4.56W/U28 3.80W
Integrated graphics	Yes
Discrete Graphics	Yes, GN20-S5
Max Operating Power	Discrete < 65W
	UMA U15 < 45W, UMA U28 < 65W
Temperature	
Operating	32° to 95° F (0° to 35° C)
	(No sustained direct exposure to sunlight)
	(System performance may be reduced above 32°C (89.6°F))
Non-operating	-4° to 140° F (-20° to 60° C)
Relative Humidity	
Operating	10% to 90%, non-condensing
Non-operating	5% to 95%
	(38.7° C (101.6° F) maximum wet bulb tempera-ture; non-condensing)
Shock	
Operating	40 G, 2 ms, half-sine
Non-operating	200 G, 2 ms, half-sine
Random Vibration	
Operating	1.043 grams
Non-operating	3.5 grams
Altitude (unpressurized)	
Operating	10,000 ft (3,048 m)
Non-operating	40,000 ft (12,192 m)
Planned Industry Standard Certifications	
Regulatory Model Number	HSN-Q32C-5
UL	Yes
CSA	Yes
FCC Compliance	Yes
ENERGY STAR <sup>®</sup>	Yes <sup>41</sup>
EPEAT <sup>®</sup>	EPEAT <sup>®</sup> Gold in the United States <sup>42</sup>
ICES	Yes
Australia /	Yes
NZ A-Tick Compliance	Yes
	Yes
Japan VCCI Compliance	Yes
КС	Yes
BSMI	Yes
CE Marking Compliance	Yes
BNCI or BELUS	Yes
CIT	Yes
EAC	Yes
Saudi Arabian Compliance (ICCP)	Yes
SABS	Yes
UKRSERTCOMPUTER	Yes
	100



- 41. Configurations of the HP ProBook 450 G9 that are ENERGY STAR<sup>®</sup> qualified are identified as HP ProBook 450 G9 ENERGY STAR on HP websites and on http://www.energystar.gov.
- 42. Based on US EPEAT<sup>®</sup> registration according to IEEE 1680.1-2018 EPEAT<sup>®</sup>. EPEAT<sup>®</sup> status varies by country. Visit http://www.epeat.net for more information.

#### DISPLAYS

Note: All specifications represent the typical specifications provided by hp's component manufacturers; actual performance may vary either higher or lower.

1. Actual brightness will be lower with touchscreen or HP Sure View.

Panel LCD 15.6 inch FHD	Outline Dimensions (W x H)	350.960 x 205.740 mm (max)	
(1920 x 1080) Anti-Glare WLED	Active Area	344.160 x 193.590 mm (typ.)	
UWVA 45percent cg 250nits eDP	Weight	380 g (max)	
1.2 w/o PSR bent Touch on Panel	Diagonal Size	15.6 inch	
NWBZ	Thickness	3.2mm/ 5.2mm (PCB) (max)	
	Interface	eDP 1.2	
	Surface Treatment	Anti-Glare On-cell	
	Touch Enabled	Yes <sup>1</sup>	
	Contrast Ratio	600:1 (typ.)	
	Refresh Rate	60 Hz	
	Brightness	250 nits	
	Pixel Resolution - Format	1920 x 1080 (FHD)	
	Backlight	LED	
	Pixel Resolution	RGB Stripe	
	Color Gamut Coverage	NTSC 45%	
	Color Depth	6 bits	
	Viewing Angle	UWVA 85/85/85/85	
	Low Blue Light	No	
	Power Consumption (W, EBL@ 150nits max/ 200nits max)	2.54 (Max) / 3.12 (Max)	

Panel LCD 15.6 inch FHD
(1920 x 1080) Anti-Glare WLED
UWVA sRGB 100percent cg
400nits eDP 1.4+PSR2 bent LP
NWBZ

Outline Dimensions (W x H) Active Area Weight Diagonal Size Thickness Interface Surface Treatment Touch Enabled Contrast Ratio Refresh Rate Brightness Pixel Resolution - Format Backlight 349.460 x 204.790 mm (max) 344.160 x 193.590 mm (typ.) 325 g (max) 15.6 inch 2.6mm / 4.6mm (PCB) (max) eDP 1.4 Anti-Glare No 1200:1 (typ.) 60 Hz 400 nits 1920 x 1080 (FHD) LED



echnical Specification	15		
	Pixel Resolution	RGB Stripe sRGB 100% (NTSC 72%)	
	Color Gamut Coverage		
	Color Depth	8 bits	
	Viewing Angle	UWVA 85/85/85	
	Low Blue Light	No	
	Power Consumption (W, EBL@ 150nits max/ 200nits max)	1.13(Max)/1.37(Max)	
Panel LCD 15.6 inch FHD	Outline Dimensions (W x H)	350.960 x 205.540mm (max)	
(1920 x 1080) Anti-Glare WLED	Active Area	344.160 x 193.590 mm (typ.)	
UWVA 45percent cg 250nits eDP	Weight	370 g (max)	
1.2 w/o PSR bent NWBZ	Diagonal Size	15.6 inch	
	Thickness	3.0 mm/ 5.0 mm (w/PCB) (max)	
	Interface	eDP 1.2 (2 lane)	
	Surface Treatment	Anti-Glare	
	Touch Enabled	No	
	Contrast Ratio	600:1 (typ.)	
	Refresh Rate	60 Hz	
	Brightness	250 nits	
	Pixel Resolution - Format	1920 x 1080 (FHD)	
	Backlight	LED	
	Pixel Resolution	RGB Stripe	
	Color Gamut Coverage	NTSC 45%	
	Color Depth	6 bits (Hi FRC supportive w/ condition to enable)	
	Viewing Angle	UWVA 85/85/85	
	Low Blue Light	No	
	Power Consumption (W, EBL@ 150nits max/ 200nits max)	2.62 (Max) / 3.27 (Max)	
Panel LCD 15.6-in HD	Outline Dimensions (W x H)	350.960 x 205.540 mm (max)	
(1366 x 768) Anti-Glare WLED	Active Area	344.230 x 193.540 mm (typ.)	
SVA 45percent cg 250nits eDP	Weight	370 g (max)	
1.2 w/o PSR NWBZ bent	Diagonal Size	15.6 inch	
	Thickness	3.2 mm / 5.0 mm (w/PCB) (max)	
	Interface	eDP 1.2 (1 lane)	
	Surface Treatment	Anti-Glare	
	Touch Enabled	No	
	Touch Enabled Contrast Ratio	No 300:1 (typ.)	
		300:1 (typ.) 60 Hz	
	Contrast Ratio Refresh Rate Brightness	300:1 (typ.) 60 Hz 250 nits	
	Contrast Ratio Refresh Rate	300:1 (typ.) 60 Hz	



Pixel Resolution	RGB Stripe
Color Gamut Coverage	NTSC 45%
Color Depth	6 bits
Viewing Angle	SVA 45/45/15/35
Low Blue Light	No
Power Consumption (W, EBL@ 150nits max/ 200nits max)	2.49 (Max) / 2.78 (Max)



#### **STORAGE AND DRIVES**

For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 and 11) is reserved for system recovery software.

is reserved for system recovery softw			
SSD 128GB 2230 PCIe NVMe Value	Form Factor	M.2 2230	
	Capacity	128GB	
	NAND Type	Value	
	Height	0.09 in (2.3 mm)	
	Width	0.87 in (22 mm)	
	Weight	0.01 lb (5 g)	
	Interface	PCIe NVMe Gen3	
	Maximum Sequential Read	Up to 2100 MB/s	
	Maximum Sequential Write	Up to 1200 MB/s	
	Logical Blocks	250,069,680	
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]	
	Features	Pyrite; TRIM; L1.2	
SSD 256GB 2230 PCIe NVMe Value	Form Factor	M.2 2230	
	Capacity	256 GB	
	NAND Type	Value	
	Height	0.09 in (2.3 mm)	
	Width	0.87 in (22 mm)	
	Interface	PCIe NVMe Gen3	
	Maximum Sequential Read	up to 2500 MB/s	
	Maximum Sequential Write	up to 1300 MB/s	
	Logical Blocks	500,118,192	
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]	
	Features	Pyrite; TRIM; L1.2	
SSD 256GB 2280 PCIe NVMe Value	Form Factor	M.2 2280	
SSD 2500B 2280 PCIE NVME Value		256GB	
	Capacity NAND Type	Value	
	Height	0.09 in (2.3 mm)	
	Width	0.87 in (22 mm)	
	Interface	PCIe NVMe Gen3	
	Maximum Sequential Read	Up to 2900 MB/s	
	Maximum Sequential Write	Up to 1400 MB/s	
	Logical Blocks	500,118,192	
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]	
	Features	ATA Security; TRIM; L1.2	
		·····	



Form Factor	M.2 2280		
Capacity	512GB		
NAND Type	Value		
Height	0.09 in (2.3 mm)		
Width	0.87 in (22 mm)		
Interface	PCIe NVMe Gen3		
Maximum Sequential Read	Up to 3500 MB/s		
Maximum Sequential Write	up to 3000 MB/s		
Logical Blocks	1,000,215,216		
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]		
Features	TRIM; L1.2		
	M.2 2280		
	1TB		
NAND Type	TLC		
Height	0.09 in (2.3 mm)		
Width	0.87 in (22 mm)		
Interface	PCIe NVMe Gen4		
Maximum Sequential Read	Up to 7,100 MB/s		
Maximum Sequential Write	Up to 5,200 MB/s		
Logical Blocks	2,000,409,264		
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]		
Features	Pyrite 2.0; TRIM; L1.2		
	Capacity NAND Type Height Width Interface Maximum Sequential Read Maximum Sequential Write Logical Blocks Operating Temperature Features Form Factor Capacity NAND Type Height Width Interface Maximum Sequential Read Maximum Sequential Write Logical Blocks		

h

## **Technical Specifications**

#### **NETWORKING/COMMUNICATIONS**

Intel® AX211 Wi-Fi 6E and W Bluetooth® 5.2 M.2 160MHz CNVi WW WLAN non-vPro <sup>1</sup>	Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11ax IEEE 802.11d IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11i IEEE 802.11i IEEE 802.11r IEEE 802.11v
I	Interoperability	Wi-Fi certified
F	Frequency Band	•802.11b/g/n/ax 2.402 - 2.482 GHz •802.11a/n/ac/ax 4.9 - 4.95 GHz (Japan) 5.15 - 5.25 GHz 5.25 - 5.35 GHz 5.47 - 5.725 GHz 5.825 - 5.850 GHz 5.955 - 6.415 GHz 6.435 - 6.515 GHz 6.535 - 6.875 GHz 6.895 - 7.115 GHz
I	Data Rates	•802.11b: 1, 2, 5.5, 11 Mbps •802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: max 300Mbps •802.11ac : 1733Mbps • 802.11ax : max 2.4Gbps
,	Modulation	Direct Sequence Spread Spectrum OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM
2	Security <sup>3</sup>	<ul> <li>•IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only</li> <li>•AES-CCMP: 128 bit in hardware</li> <li>•802.1x authentication</li> <li>•WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.</li> <li>•WPA2 certification</li> <li>•WPA3 certification</li> <li>•IEEE 802.11i</li> <li>•WAPI</li> </ul>
	Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
-	Roaming	IEEE 802.11 compliant roaming between access points
	Output Power <sup>2</sup>	• 802.11b : +17dBm minimum
•		

	<ul> <li>802.11n HT40(2</li> <li>802.11n HT20(2</li> <li>802.11n HT40(2</li> <li>802.11ac VHT8</li> <li>802.11ac VHT1</li> <li>802.11ac HE40</li> <li>802.11ax HE80</li> </ul>		
Power Consumption	•Transmit mode2.0 W •Receive mode1.6 W •Idle mode (PSP)180 mW(WLAN Associated) •Idle mode50 mW(WLAN unassociated) •Connected Standby 10mW •Radio disabled8 mW		
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode		
Receiver Sensitivity <sup>4</sup>	<ul> <li>802.11b, 1Mbps : -93.5dBm maximum</li> <li>802.11b, 11Mbps : -84dBm maximum</li> <li>802.11a/g, 6Mbps : -86dBm maximum</li> <li>802.11a/g, 54Mbps : -72dBm maximum</li> <li>802.11a, g, 54Mbps : -72dBm maximum</li> <li>802.11n, MCS07 : -67dBm maximum</li> <li>802.11n, MCS15 : -64dBm maximum</li> <li>802.11ac, MCS0(VHT80) : -84dBm maximum</li> <li>802.11ac, MCS9(VHT80) : -59dBm maximum</li> <li>802.11ac, MCS9(VHT80) : -58.5dBm maximum</li> <li>802.11ax, MCS11(HE40): -57dBm maximum</li> <li>802.11ax, MCS11(HE40): -54dBm maximum</li> <li>802.11ax, MCS11(HE80): -53.5dBm maximum</li> </ul>		
Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications		
Form Factor	PCI-Express M.2 MiniCard		
Dimensions	1. Type 2230 : 2.3 x 22.0 x 30.0 mm 2. Type 1216: 1.67 x 12.0 x 16.0 mm		
Weight	1. Type 2230 : 2.8g 2. Type 1216: 1.3g		
Operating Voltage	3.3v +/- 9%		
Temperature	Operating Non-operating	14° to 158° F (–10° to 70° C) –40° to 176° F (–40° to 80° C)	
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)	
Altitude	Operating	0 to 10,000 ft (3,048 m)	



	Non-operating 0 to 50,000 ft (15,240 m)
LED Activity	LED Amber – Radio OFF; LED OFF – Radio ON
HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0	D/5.1/5.2 Wireless Technology
Bluetooth Specification	4.0/4.1/4.2/5.0/5.1/5.2 Compliant
Frequency Band	2402 to 2480 MHz
Number of Available Channels	Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH)
Data Rates and Throughput	Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps BLE : 1 Mbps data rate; throughput up to 0.2 Mbps Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 9.5 dBm for BR and EDR.

1. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

3. Check latest software/driver release for updates on supported security features.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).



Realtek RTL8852BE 802.11ax 2x2 Wi-Fi® + Bluetooth® 5.2 (802.11ax 2x2, supporting gigabit data rate) <sup>1</sup>	Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11ax IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11i IEEE 802.11i IEEE 802.11k IEEE 802.11v
	Interoperability Frequency Band	Wi-Fi certified modules •802.11b/g/n/ax 2.402 – 2.482 GHz •802.11a/n/ac/ax 4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz
	Data Rates	•802.11b: 1, 2, 5.5, 11 Mbps •802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: max 300Mbps •802.11ac: max 866.7Mbps • 802.11ax: max 1201Mbps
	Modulation	Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM
	Security <sup>3</sup>	<ul> <li>IEEE and WiFi certified 64 / 128 bit WEP encryption for a/b/g mode only</li> <li>AES-CCMP: 128 bit in hardware</li> <li>802.1x authentication</li> <li>WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.</li> <li>WPA2 certification</li> <li>WPA3 certification</li> <li>IEEE 802.11i</li> <li>WAPI</li> </ul>
	Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
	Roaming	IEEE 802.11 compliant roaming between access points
	Output Power <sup>2</sup>	<ul> <li>802.11b : +18.5dBm minimum</li> <li>802.11g : +17.5dBm minimum</li> <li>802.11a : +18.5dBm minimum</li> <li>802.11n HT20(2.4GHz) : +15.5dBm minimum</li> <li>802.11n HT40(2.4GHz) : +14.5dBm minimum</li> <li>802.11n HT20(5GHz) : +15.5dBm minimum</li> </ul>



## **Technical Specifications**

	• 802.11ac VHT8 • 802.11ax HE40	5GHz) : +14.5dBm minimum 80(5GHz) : +11.5dBm minimum 9(2.4GHz) : +10dBm minimum 9(5GHz) : +10dBm minimum
Power Consumption	•Idle mode:50 m	2 W )180 mW(WLAN Associated) W(WLAN unassociated) Idby/Modern Standby: 10mW
Power Management		ress compliant power management It power saving mode
Receiver Sensitivity <sup>4</sup>	802.11b, 11Mbp 802.11a/g, 6Mb 802.11a/g, 54Ml 802.11n, MCS07 802.11n, MCS15 802.11ac, MCS0 802.11ac, MCS9 •802.11ax, MCS	: -93.5dBm maximum s: -84dBm maximum ps: -86dBm maximum bps: -72dBm maximum : -67dBm maximum : -64dBm maximum : -84dBm maximum : -59dBm maximum 11 (HE40): -57dBm maximum 11 (HE80): -54dBm maximum
Antenna type	enclosure. Two embedded o	ntenna with spatial diversity, mounted in the display dual band 2.4/5 GHz antennas are provided to the card to IMO communications and Bluetooth communications
Form Factor	PCI-Express M.2	MiniCard
Dimensions		3 x 22.0 x 30.0 mm 67 x 12.0 x 16.0 mm
Weight	1. Туре 2230: 2. 2. Туре 126: 1.3	-
Operating Voltage	3.3v +/- 9%	
Temperature	Operating Non-operating	14° to 158° F (–10° to 70° C) –40° to 176° F (–40° to 80° C)
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)
Altitude	Operating	0 to 10,000 ft (3,048 m)
	Non-operating	0 to 50,000 ft (15,240 m)
LED Activity	LED Amber – Rad LED Off – Radio	•
HP Integrated Module with Bluetooth 4.0/4.1/4.2/	/5.0/5.1/5.2 Wireles	s Technology
Bluetooth Specification		5.1 Compliant/5.2 Compliant
Frequency Band	2402 to 2480 MI	
Number of Available	Legacy: 0~79 (1	

BLE: 0~39 (2 MHz/CH)

Channels

Data Rates and Throughput	Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps BLE: 1 Mbps data rate; throughput up to 0.2 Mbps Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.

1. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 (802.11ax) is backwards compatible with prior 802.11 specs. Wi-Fi 6 is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

3. Check latest software/driver release for updates on supported security features.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

Intel® XMM™ 7560 R+ LTE-Advanced Pro¹	Technology/Operating bands	FDD LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3), 1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 14 upper), 700 (Band 17 lower), 850 (Band 18 lower), 850 (Band 19 upper), 800 (Band 20), 1900 (Band 25), 850 (Band 26), 700 (Band 28), 700 (Band 29 RX only), 2300 (Band 30), 1700/2100 (Band 66), 600 (band 71). TDD LTE: 2100 (Band 34), 2600 (Band 38), 1900 (Band 39), 2400 (Band 40), 2500 (Band 41), 3500 (Band 42), 3700 (Band 43), 3700 (band 48), 5200 (Band 46 RX only) MHz; HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4), 850 (Band 5), 900 (Band 8) MHz
	Wireless protocol	3GPP Release 12 LTE Specification DL-CAT.16, DL 100MHz BW
	standards	throughput up to 978Mbps; UL-CAT.13 40MHz throughput up to 150Mbps WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification
	GPS	Standalone GPS/Beidou/Glonass, A-GPS (MS-A, MS-B)
	GPS bands	1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz, Beidou 1561.098 MHz
	Maximum data rates	LTE: 978 Mbps (Download), 150 Mbps (Upload) DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)
	Maximum output	LTE: 23 dBm in all band except B41
	power	LTE B41 HPUE = 26dBm HSPA+: 23.5 dBm
	Maximum power	LTE: 1,200 mA (peak); 900 mA (average)
	consumption	HSPA+: 1,100 mA (peak); 800 mA (average)
	Form Factor	M.2, 3042-S3 Key B
	Weight	6 g



## **Technical Specifications**

Dimensions (Length x Width x Thickness) eSIM 42 x 30 x 2.3 mm

Support

1. Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products or in all countries.

Realtek RTL8111HSH 10/100/1000 Integrated NIC	Ethernet Features	10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14) 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21- 30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s
	Power Management	ACPI compliant – multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power consumption
	Performance Features	TCP/IP/UDP Checksum Offload (configurable) Protocol Offload (ARP & NS) Large send offload and Giant send offload Receiving Side Scaling Jumbo Frame 9K
	Manageability	Wake-on-LAN from modern standby or sleep state (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only) PXE 2.1 Remote Boot Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30)) Comprehensive diagnostic and configuration software suite Virtual Cable Doctor for Ethernet cable status
	Interface NIC Device Driver Name	PCIe + SMBus Realtek PCIe GBE Ethernet Family Controller



#### POWER

AC Adapter 45 Watt nPFC Standard USB	Dimensions Weight	94.0 mm x 40.0 mm x 26.5 mm 192.5g +/-10%
type C Straight 1.8m	Input Input Efficiency	Average Efficiency of 25%, 50%, 75%, 100% load condition with 115Vac/230Vac Spec: 5V: 81.5%
		9V: 86.7% 12V: 87.41% 15V: 87.8%
	Input frequency range	47 to 63 Hz
	Input AC current	Max. 1.4 A at 90 Vac
	Output	
	Output power	5V/15W 9V/27W 12V/36W 15V/45W
	DC output	5V/9V/12V/15V
	Hold-up time	50,50,120,150 5ms at 115 Vac input
	Output current limit	<5.0A
	Connector	USB Type-C
	Environmental Design	
	Operating temperature	32° to 95° F (0° to 35° C)
	Non-operating (storage) temperature	-4° to 185° F (-20° to 85° C)
	Altitude	0 to 16,400 ft (0 to 5000m)
	Humidity	20% to 95%
	Storage Humidity	10% to 95%
	EMI and Safety Certifications	Eg. *CE Mark - full compliance with LVD and EMC directives *Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. *MTBF - over 200,000 hours at 25°C ambient condition.

AC Adapter 45 Watt
Smart nPFC Standard
Barrel 4.5mm Right
Angle 1.8m

Dimensions Weight Input Input Efficiency Input frequency range Input AC current Output Output Output DC output Hold-up time

95 x 45 x 26.5 mm unit: 200g +/- 10g 87.74 % at 115 Vac and 88.4 % at 230Vac 47 ~ 63 Hz Max. 1.4 A at 90 Vac 45W 19.5V 5ms at 115 Vac input



	Output current limit	<8.0A
	Connector	4.5mm Barrel Type
	Environmental Design	
	Operating temperature	32° to 95° F (0° to 35° C)
	Non-operating (storage) temperature	-4° to 185° F (-20° to 85° C)
	Altitude	0 to 16,400 ft (0 to 5000m)
	Humidity	20% to 95%
	Storage Humidity	10% to 95%
	EMI and Safety	Eg:
	Certifications	*CE Mark - full compliance with LVD and EMC directives * Worldwide safety standards - IEC60950-1 and/or IEC62368-1, EN60950-1 and/or EN62368-1, UL60950-1 and/or UL62368-1, Class1, SELV;
		Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC, NOM-001 NYCE. * MTBF - over 200,000 hours at 25°C ambient condition.
AC Adapter 65 Watt	Dimensions	90.0 x 51 x 28.5mm
nPFC Standard USB	Weight	unit: 250g +/- 10g
type C Straight 1.8m	Input	
	Input Efficiency	Average Efficiency of 25%, 50%, 75%, 100% load condition with
		115Vac/230Vac Spec:
		5V: 81.5%
		9V: 86.7%
		12V: 88%
		15V: 88%
		20V: 89%
	Input frequency range	47 ~ 63Hz
	Input AC current	1.6 A at 90 VAC and maximum load
	Output	
	Output power	5V/15W
		9V/27W 12V/60W
		15V/60W
		20V/65W
	DC output	5V/9V/12V/15V/20V
	Hold-up time	5ms at 115 Vac input
	Output current limit	<8.0A
	Connector	USB Type-C
	Environmental Design	
	Operating temperature	32° to 95° F (0° to 35° C)
	Non-operating (storage)	-4° to 185° F (-20° to 85° C)
	temperature	
	Altitude	0 to 16,400 ft (0 to 5000m)
	Humidity	20% to 95%

Storage Humidity	10% to 95%
EMI and Safety	Eg:
Certifications	*CE Mark - full compliance with LVD and EMC directives * Worldwide safety standards - IEC60950-1 and/or IEC62368-1, EN60950-1 and/or EN62368-1, UL60950-1 and/or UL62368-1, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC, NOM-001 NYCE. * MTBF - over 200,000 hours at 25°C ambient condition.

AC Adaptor CE Watt	Dimensions	102 x 55 x 30mm
AC Adapter 65 Watt Smart nPFC EM Barrel		
4.5mm New EM	Weight	unit: 250g +/- 10g
4.511111 NEW EM	Input	
	Input Efficiency	88.0 % at 115 Vac and 89.0 % at 230Vac
	Input frequency range	47 ~ 63 Hz
	Input AC current	Max. 1.7 A at 90 Vac
	Output	
	Output power	65W
	DC output	19.5V
	Hold-up time	5ms at 115 Vac input
	Output current limit	<11.0A
	Connector	4.5mm Barrel Type
	Environmental Design	
	Operating temperature	32°F to 95°F (0°to 35°C)
	Non-operating (storage)	-4ºF to 185ºF (-20ºto 85ºC)
	temperature	
	Altitude	0 to 16,400 ft (0 to 5000m)
	Humidity	20% to 95%
	Storage Humidity	10% to 95%
	EMI and Safety	Eg:
	Certifications	*CE Mark - full compliance with LVD and EMC directives * Worldwide safety standards - IEC60950-1 and/or IEC62368-1, EN60950-1 and/or EN62368-1, UL60950-1 and/or UL62368-1, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC
		Class B, CISPR32 Class B, CCC, NOM-001 NYCE.

\* MTBF - over 200,000 hours at 25°C ambient condition.



reennear Speen		
AC Adapter 65 Watt	Dimensions	90 x 51 x 28.5mm
Smart nPFC Standard	Weight	230g +/-10%
Barrel 4.5mm Right	Input	
Angle 1.8m	Input Efficiency	88.0 % at 115 Vac and 89.0 % at 230 Vac
	Input frequency range	47 ~ 63 Hz
	Input AC current	Max. 1.7 A at 90 Vac
	Output	
	Output power	65W
	DC output	19.5V
	Hold-up time	5 ms at 115 Vac input
	Output current limit	<11.0A
	Connector	4.5mm Barrel Type
	Environmental Design	
	Operating temperature	32°F to 95°F (0°to 35°C)
	Non-operating (storage)	-4°F to 185°F (-20°to 85°C)
	temperature	0 + 15 + 100 + (0 + 5000 - 1)
	Altitude Humidity	0 to 16,400 ft (0 to 5000m) 20% to 95%
	Storage Humidity	10% to 95%
	EMI and Safety	Eg:
	Certifications	*CE Mark - full compliance with LVD and EMC directives
		* Worldwide safety standards - IEC60950-1 and/or IEC62368-1,
		EN60950-1 and/or EN62368-1, UL60950-1 and/or UL62368-1,
		Class1, SELV;
		Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC, NOM-001 NYCE.
		* MTBF – over 200,000 hours at 25°C ambient condition.
RH 42Whr Long Life	Dimensions (H x W x L)	6.2 x 76.25 x 249.50 mm (0.244 x 3.002 x 9.823 inch)
Polymer Fast Charge 3	Weight	0.18 kg (0.397 lb)
cell Battery	Cells/Type	3cell Lithium-Ion Polymer cell / 545974
	Energy	
	Voltage	11.4V
	Amp-hour capacity	3.752Ah
	Watt-hour capacity	42.75Wh
	Temperature	
	Operating (Charging)	32° to 113° F (0° to 45° C)
	Operating (Discharging)	14° to 122° F (-10° to 60° C)
	Fuel Gauge LED	NA
	Warranty	Follow product spec
	Optional Travel Battery	No
	Available	



RH 51Whr Long Life Polymer Fast Charge 3 cell Battery	Dimensions (H x W x L) Weight Cells/Type Energy	6.50 x 67.80 x 254.00 mm (0.256 x 2.669 x 10 inch) 0.2025 kg (0.446 lb) 3cell Lithium-Ion Polymer cell / 566075
	Voltage	11.58V
	Amp-hour capacity	4.431Ah
	Watt-hour capacity	51.3Wh
	Temperature	
	Operating (Charging)	32° to 113° F (0° to 45° C)
	Operating (Discharging)	14° to 122° F (-10° to 60° C)
	Fuel Gauge LED	NA
	Warranty	Follow product spec
	Optional Travel Battery Available	Νο



## **Technical Specifications**

#### AUDIO

HD Stereo Codec	ALC3247-CG
Audio I/O Ports	Headset: CTIA only and Headphone-out
Internal Speaker Amplifier	ALC 3247 has Embedded Class-D 2W Stereo Amplifier
Multi-streaming Capable	Playback multi-streaming can be enabled in the audio control panel to allow independent audio.
	Following MSFT Behavior
Sampling	DAC:44.1k/48kHz
	ADC:48kHz
Wavetable Syntheses	NA
Analog Audio	Support 3.5mm Headset: CTIA only and Headphone-out
# of Channels on Line-Out	NA
Internal Speaker	Yes
•	

#### **FINGERPRINT READER**

Sensor vendor	Elan efsa80ST
Sensor type	Capacitive
DPI resolution	508 dpi
Scan area	80*80 pixels
False Rejection Rate	<3%
False Acceptance Rate	1/100K
Mobile Voltage Operation	2.7V to 3.6V
Operating Temperature	-4 – 175°F (-20° ~ +80°C)
Current Consumption	50mA peak
Image	
Low Latency Wait For	900uA
Finger	
Capture Rate	30 frame/sec
ESD Resistance	+15KV
<b>Detection Matrix</b>	80*80 pixels/ 508 dpi / 4*4mm sensor area



#### **ENVIRONMENTAL DATA**

Off	1 BTU/hr	1.1 BTU/hr	1 BTU/hr	
idle) Sleep	3.1 BTU/hr 3.1 BTU/hr	3.5 BTU/hr 3.5 BTU/hr	3.1 BTU/hr 3.1 BTU/hr	
Normal Operation (Long			2.1 DTU/br	
idle)	17.8 BTU/hr	17.7 BTU/hr	18.5 BTU/hr	
Normal Operation (Short	I I SVAL, BUHZ	23UVAL, SUHZ	IUUVAL, SUHZ	
Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz	
	family does not offer ENERGY STAR <sup>®</sup> compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows <sup>®</sup> operating system.			
			R <sup>®</sup> specifications for computers. If a model	
	family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S.			
	Note: Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model			
Off	0.29 W	0.31 W	0.29 W	
Sleep	0.91 W	1.01 W	0.92 W	
idle)	0.91 W	1.01 W	0.92 W	
Normal Operation (Long	J.2 I W	J.17 VV	J.+1 W	
Normal Operation (Sort idle)	5.21 W	5.17 W	5.41 W	
method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz	
ENERGY STAR® test				
(in accordance with US				
Energy Consumption				
	Notebook model is based on a "Typically Configured Notebook".			
System Configuration				
	<ul> <li>Molded Paper Pulp Cushion inside box is 100% sustainably sourced and recyclable</li> <li>Bulk packaging available</li> </ul>			
	-			
	Low halogen     Outside Box and corruga	ted cushions are 100% cus	tainably sourced and recyclable	
Specifications	• 10% post-consumer recy	/cled plastic		
Sustainable Impact	Ocean-bound plastic in S	peaker		
	<ul> <li>Korea Eco-tabet</li> <li>Japan PC Green la</li> </ul>	ıbel*		
	<ul> <li>Taiwan Green Mai</li> <li>Korea Eco-label</li> </ul>	rk		
	China State Envir	onmental Protection Admir	istration (SEPA)	
	<ul> <li>TCO Certified</li> <li>China Energy Con</li> </ul>	servation Program (CECP)		
	status in your cou		· · · -	
			See http://www.epeat.net for registration	
	US ENERGY STAR®     US Federal Energy	® y Management Program (FE		
	IT ECO declaration			
declarations	be labeled with one or mo	• •		
Eco-Label Certifications &	This product has received	or is in the process of being	certified to the following approvals and may	



Γ

## Technical Specifications

1

	*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.			
Declared Noise Emissions	Sound Power Sound Pressure			essure
(in accordance with ISO 7779 and ISO 9296)				cibels)
Typically Configured – Idle		2.6	15.	4
Fixed Disk – Random writes		2.7	15.	6
Optical Drive – Sequential reads	3.2 29.8			8
Longevity and Upgrading		can be upgraded, possibly e /or components contained ii	xtending its useful life by seve 1 the	eral years. Upgradeable
	Spare parts a of production		warranty period and or for up	to "5" years after the end
Additional Information	<ul> <li>This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.</li> <li>This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.</li> <li>This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).</li> <li>This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net</li> <li>Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.</li> <li>This product is 93.3% recycle-able when properly disposed of at end of life.</li> </ul>			
Packaging Materials	External:	PAPER/Corrugated	0.295 g	
		PAPER/Molded Pulp	0.192 g	
	Internal:	PLASTIC/Polyethylene low	<i>i</i> density - LDPE	0.010 g
			at least 0.0% recycled conten	
	-		als contains at least 60.6% rec	-
RoHS Compliance	HP Inc. complies fully with materials regulations. We were among the first companies to extend the restrictions in the European Union (EU) Restriction of Hazardous Substances (RoHS) Directive to our products worldwide through the HP GSE. HP has contributed to the development of related legislation in Europe, as well as China, India, and Vietnam. We believe the RoHS directive and similar laws play an important role in promoting industry-wide elimination of substances of concern. We have supported the inclusion of additional substances—including PVC, BFRs, and certain phthalates—in future RoHS legislation that pertains to electrical and electronics products. We met our voluntary objective to achieve worldwide compliance with the new EU RoHS requirements for virtually all relevant products by July 2013, and we will continue to extend the scope of the commitment to include further restricted substances as regulations continue to evolve. To obtain a copy of the HP RoHS Compliance Statement, see HP RoHS position statement.			
Material Usage	This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html			



	):
	Asbestos
	Certain Azo Colorants
	• Certain Brominated Flame Retardants – may not be used as flame retardants in plastics
	Cadmium
	Chlorinated Hydrocarbons
	Chlorinated Paraffins
	Bis(2-Ethylhexyl) phthalate (DEHP)
	Benzyl butyl phthalate (BBP)
	Dibutyl phthalate (DBP)
	Diisobutyl phthalate (DIBP)
	Formaldehyde
	Halogenated Diphenyl Methanes
	Lead carbonates and sulfates
	Lead and Lead compounds
	Mercuric Oxide Batteries
	<ul> <li>Nickel – finishes must not be used on the external surface designed to be frequently</li> </ul>
	handled or carried by the user.
	Ozone Depleting Substances
	Polybrominated Biphenyls (PBBs)
	Polybrominated Biphenyl Ethers (PBBEs)
	Polybrominated Biphenyl Oxides (PBBOs)
	Polychlorinated Biphenyl (PCB)
	Polychlorinated Terphenyls (PCT)
	<ul> <li>Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has</li> </ul>
	been voluntarily removed from most applications.
	Radioactive Substances     T it is a fit (TDT) T it is a fit (TDT)
	Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)
Packaging Usage	HP follows these guidelines to decrease the environmental impact of product packaging:
	• Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in
	packaging materials.
	<ul> <li>Eliminate the use of ozone-depleting substances (ODS) in packaging materials.</li> </ul>
	<ul> <li>Design packaging materials for ease of disassembly.</li> </ul>
	Maximize the use of post-consumer recycled content materials in packaging materials.
	Use readily recyclable packaging materials such as paper and corrugated materials.
	<ul> <li>Reduce size and weight of packages to improve transportation fuel efficiency.</li> </ul>
	• Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.
End-of-life Management	HP offers end-of-life HP product return and recycling programs in many geographic areas. To
and Recycling	recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest
	HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible
	manner.
	The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information
	for each product type for use by treatment facilities. This information (product disassembly
	instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers.
	These instructions may be used by recyclers and other WEEE treatment facilities as well as HP
	OEM customers who integrate and re-sell HP equipment.



## **Technical Specifications**

HP,	Inc.	Corporate	For more information about HP's commitment to the environment:	
Enviro Inform	nmental Nation		Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Eco-label certifications http://www8.hp.com/us/en/hp-information/environment/ecolabels.html ISO 14001 certificates: http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842 and http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf	
footno	otes		<ul> <li>Percentage of ocean-bound plastic contained in each component varies by product</li> <li>Recycled plastic content percentage is based on the definition set in the IEEE 1680.1-2018 standard.</li> <li>External power supplies, WWAN modules, power cords, cables and peripherals excluded.</li> <li>100% outer box packaging and corrugated cushions made from sustainably sourced certified and recycled fibers.</li> <li>Fiber cushions made from 100% recycled wood fiber and organic materials.</li> </ul>	

#### **COUNTRY OF ORIGIN**

China



## Options and Accessories (sold separately and availability may vary by country)

DOCKING (Sold Separately) Docking station model #1	HP USB-C Dock G5
Total number of supported displays (incl. the notebook display)	3
Max. resolutions supported	Dual 5K@ 30Hz + 1 4K UHD (multi-function mode) 5120x2880 Highest resolution with dual displays is two 8K@ 60Hz host in High Resolution mode.
Dock Connectors	1xHDMI, 2xDP
Technical limitations	Highest resolution with dual displays is two 8K@ 60Hz host in High Resolution mode.
	Three maximum displays supported are two 5K@ 30 Hz on DP ports plus one 4K UHD@ 30 Hz on HDMI in Multi-function mode
	The highest resolution for a non-Thunderbolt host in Multi-function mode is a single 5K dual cable (using both DP ports) + (1) 4K on HDMI port .
Docking station model #2	HP USB-C/A Universal Dock G2
Total number of supported displays (incl. the notebook display)	3
Max. resolutions supported	Triple 4K UHD@ 60Hz 3840x2160
Dock Connectors	1xHDMI, 2xDP
Technical limitations	The best resolution for dual or triple displays is 4K UHD@ 60Hz. For use with the USB-A adapter that comes in the box the maximum number of displays supported is (2) 4k x 60 Hz on the Type-A Gen 1 connection from the host
Docking station model #3	HP Thunderbolt Dock G2
Total number of supported displays (incl. the notebook display)	4
Max. resolutions supported	Dual 4K @30Hz or dual 4K UHD @ 60Hz is supported Single 8K@ 60Hz for Thunderbolt hosts or USB-C hosts DP 1.4 with DSC in high res mode.
Dock Connectors	2xDP, 1xVGA, 1xTB, 1xUSB-C alt-mode
Technical limitations	Thunderbolt Hosts: Maximum of (4) displays with maximum resolution of 5K@ 30Hz running Thunderbolt host.
	Maximum resolution possible is dual 8K displays @ 60Hz running Thunderbolt
	host or running a non-Thunderbolt host in high resolution mode @30Hz
	Non-Thunderbolt hosts:
	The highest resolution for dual displays running a non-Thunderbolt host in multi-function mode is
	(1) 5K dual cable (using both DP ports) +(1) 4K on USB-C DP port
	Non-Thunderbolt hosts support (3) displays with a maximum resolution of (2) 5K single cable + (1) 4K UHD @ 60 Hz in high resolution mode. In multi- function mode the maximum resolution for (3) displays is (2) 5K single cable @ 30Hz + (1) 4K UHD @ 30Hz.



## Options and Accessories (sold separately and availability may vary by country)

Category	Description	Part Number
Audio/Video	HP Wired USB-A Stereo Headset	428K6AA
-	HP Wired 3.5mm Stereo Headset	428K7AA
Cases	HP Business Slim 17.3 Top Load	2UW02AA
	HP Executive 15.6 Backpack	6KD07AA
	HP Executive 15.6 Top Load	6KD06AA
	HP Executive 17.3 Backpack	6KD05AA
	HP Executive 17.3 Top Load	6KD08AA
	HP Executive Leather 15.6 Top Load	6KD09AA
	HP Prelude G2 15.6 Backpack	1E7D6AA
	HP Prelude G2 15.6 Top Load	1E7D7AA
	HP Prelude Pro Recycled 15.6 Backpack	1X644AA
	HP Prelude Pro Recycled 15.6 Top Load	1X645AA
	HP Renew Business 17.3 Laptop Backpack	3E2U5AA
	HP Renew Business 17.3 Laptop Bag	3E2U6AA
	HP Renew Business 15.6 Laptop Bag	3E5F8AA
Docking	HP Thunderbolt 120W G2 Dock	2UK37AA
	HP Thunderbolt 120W G2 Dock w/Audio	3YE87AA
	HP Thunderbolt 120W G4 Dock	4J0A2AA
	HP Thunderbolt 230W G2 Dock w/Combo Cable	3TR87AA
	HP Thunderbolt 280W G4 Dock w/Combo Cable	4JOG4AA
	HP USB-C/A 120W G2 Universal Dock	5TW13AA
	HP USB-C Dock G5	5TW10AA
Hub	HP USB-C Mini Dock	1PM64AA
	HP Universal USB-C Multiport Hub	50H55AA
	HP USB-C Travel Dock G2	7PJ38AA
	HP USB-C to USB-A Hub	Z6A00AA
Adapter	HP HDMI to DVI Adapter	F5A28AA
•	HP HDMI to VGA Adapter	H4F02AA
	HP USB-C to DisplayPort Adapter	N9K78AA
	HP USB-C to HDMI 2.0 Adapter	1WC36AA
	HP USB-C to USB 3.0 Adapter	N2Z63AA
	HP USB-C to VGA Adapter	N9K76AA
Keyboard/Combo	HP 975 USB+BT Dual-Mode Wireless Keyboard	3Z726AA
	HP 455 Programmable Wireless Keyboard	4R177AA
	HP 125 WD USB Keyboard	266C9AA
	HP 320K WD USB Keyboard	9SR37AA
	HP 655 Wireless Keyboard and Mouse Combo	4R009AA



## Options and Accessories (sold separately and availability may vary by country)

•		
	HP 225 Wired Mouse and Keyboard Combo	286J4AA
	HP 235 Wireless Mouse and Keyboard Combo	1Y4DOAA
	HP Slim Wireless Keyboard and Mouse	T6L04AA
	HP Wired Desktop 320MK Mouse and Keyboard	9SR36AA
	HP Wireless Rechargeable 950MK Mouse and Keyboard	3M165AA
Mouse	HP USB Premium Wireless Mouse	1JR31AA
	HP 435 Multi-Device Wireless Mouse	3B4Q5AA
	HP 125 USB-A Wired Mouse	265A9AA
	HP 128 USB Laser Wired Mouse	265D9AA
	HP 320M USB-A Wired Mouse	9VA80AA
	HP Creator USB-A+Bluetooth 935 Wireless Mouse Black	1DOK8AA
	HP USB-A+Bluetooth Multi-Device 635 Wireless Mouse Black	1DOK2AA
	HP USB-A+Bluetooth Travel Bluetooth Mouse	6SP30AA
Power	HP 65W USB-C Auto Chevy AC Power Adapter	5TQ76AA
	HP 45W 4.5 mm Smart AC Power Adapter	H6Y88AA
	HP 45W USB-C G2 Zeus AC Power Adapter	1HE07AA
	HP 45W USB-C LC Dali AC Power Adapter	1MZ01AA
	HP 65W 4.5 mm LC Smart non-EM India Ony AC Power Adapter	3FF84AA#ACJ
	HP 65W 4.5 mm Smart AC Power Adapter	H6Y89AA
	HP 65W 4.5 mm wDongle 7.4 mm Slim AC Power Adapter	H6Y82AA
	HP 65W USB-C Hades AC Power Adapter	1HE08AA
	HP 65W USB-C LC AC Power Adapter	1РЗК6АА
Commodity	HP USB DVD-Writer EXT ODD	F2B56AA
commonly	HP Nano Keyed Cable Lock	1AJ39AA
	HP Nano Master Keyed Cable Lock	1AJ40AA
	HP SureKey Standard/Nano/Wedge Cable Lock	6UW42AA
	in Succey Standard Hand, Wedge Cubic Lock	COWIERA



## Summary of Changes

Date of change:	Version History:	Updated	Description of change:
March 28, 2022	V1 to V2	Added	Environmental Data
April 11, 2022	V2 to V3	Added	Reference for USB ports
	V3 to V4		

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